Tyrone Camarero Specifications



Camarero-SDI100C3S-112

Key Feature

Database Applications, Hyperscale Data Center, Object Storage, Big Data Analytics, Scale-Out Density, Hadoop & Ceph storage solutions, Scale-out NAS

- Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable processors, Supports 120W - 205W TDP CPUs.
- Up to 4TB ECC DDR4-3200: LRDIMM/RDIMM
- 2x 25G SFP+ Ports Onboard
- 12x 3.5" hot-swap SAS/SATA, 4x hot-swap EDSFF Short Bays, 2x 2.5" 7mm NVMe/Hot-Swap SATA drive bays, 4x E1.S (EDSFF Short) NVMe drives
- Host Bus Adapter via Broadcom® 3224
- PCle 4.0 x16 AIOM Support + 3 PCle 4.0 LP Slots
- 6 Heavy Duty 4cm Fans
- 800W Redundant Platinum Level power supplies





Processor/Cache

Processor Dual Socket P+ (LGA-4189) 3rd Gen Intel®

Xeon® Scalable processors, Supports 120W -

205W TDP CPUs (Air cooled).

System Memory

Memory16 DIMM slots, Up to 4TB: 16x 256 GBCapacityDRAM, Memory Type: 3200MHz ECC

DDR4 RDIMM; LRDIMM

Chipset

Chipset Intel® C621A

Expansion Slot

PCI-Express 2 PCIe 4.0 x16 LP slot(s), 1 PCIe 4.0 x8 LP

slot(s), 1 PCIe 4.0 x16 AIOM slot(s).

Note PCIe slot 1 is occupied by the Storage

Controller

Integrated Onboard

Network Connectivity

2x 25GbE SFP28 with Mellanox

IPMI

Support for Intelligent Platform Management Interface v.2.0, IPMI 2.0 with virtual media over LAN and KVM-

over-LAN support

Add-on Options

Raid Card

Optional

Optical Drive

None

Front Panel

LED: HDD activity, Network activity,

Power status, System information

(overheat/UID)

Buttons Power On/Off

Drive bays

HDD Bays 12x 3.5" hot-swap SATA3/SAS3 drive

bays, 4x E1.S and 2x 2.5" 7mm, 2 M.2 NVMe OR 2 M.2 SATA3 , M-Key, 2280

Power Supply

Power Supply 800W Redundant Platinum Level

power supplies

Cooling System

Fans 6 Heavy Duty 4cm Fan(s)

Form Factor

Form Factor 1U Rackmount

Dimensions

Dimensions Dimensions : Height -1.7", Width -17.6",

Depth -37"

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For more/current product information, Visit
www.tyronesystems.com

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